

# RGW00TS65

## 650V 50A Field Stop Trench IGBT

$V_{CES}$	650V
I <sub>C (100°C)</sub>	50A
V <sub>CE(sat) (Typ.)</sub>	1.5V
$P_D$	254W

### ● Features

- 1) Low Collector Emitter Saturation Voltage
- 2) High Speed Switching
- 3) Low Switching Loss & Soft Switching
- 4) Pb free Lead Plating; RoHS Compliant

### Applications

**PFC** 

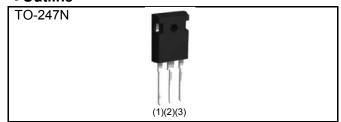
**UPS** 

Welding

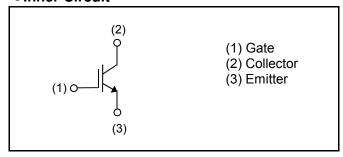
Solar Inverter

ΙH

#### Outline



### ●Inner Circuit



Packaging Specifications

	Packaging	Tube	
	Reel Size (mm)	-	
Typo	Tape Width (mm)	-	
Туре	Basic Ordering Unit (pcs)	450	
	Packing Code	C11	
	Marking	RGW00TS65	

### ● Absolute Maximum Ratings (at T<sub>C</sub> = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V <sub>CES</sub>	650	V
Gate - Emitter Voltage		V <sub>GES</sub>	±30	V
Collector Current	T <sub>C</sub> = 25°C	I <sub>C</sub>	96	А
	T <sub>C</sub> = 100°C	I <sub>C</sub>	50	А
Pulsed Collector Current		I <sub>CP</sub> *1	200	А
Dawar Dissination	T <sub>C</sub> = 25°C	P <sub>D</sub>	254	W
Power Dissipation	T <sub>C</sub> = 100°C	P <sub>D</sub>	127	W
Operating Junction Temperature		Tj	-40 to +175	°C
Storage Temperature		T <sub>stg</sub>	–55 to +175	°C

<sup>\*1</sup> Pulse width limited by T<sub>imax</sub>.

### ●Thermal Resistance

Parameter	Symbol	Values			Unit
r ai ai iletei		Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	ı	ı	0.59	°C/W

## ●IGBT Electrical Characteristics (at T<sub>j</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
r arameter Sy	Syllibol		Min.	Тур.	Max.	Offic
Collector - Emitter Breakdown Voltage	BV <sub>CES</sub>	$I_C = 10 \mu A, V_{GE} = 0 V$	650	1	1	V
Collector Cut - off Current	I <sub>CES</sub>	V <sub>CE</sub> = 650V, V <sub>GE</sub> = 0V	-	-	10	μΑ
Gate - Emitter Leakage Current	I <sub>GES</sub>	$V_{GE} = \pm 30V, V_{CE} = 0V$	-	-	±200	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	V <sub>CE</sub> = 5V, I <sub>C</sub> = 33.0mA	5.0	6.0	7.0	V
Collector - Emitter Saturation Voltage	V <sub>CE(sat)</sub>	$I_C = 50A$ , $V_{GE} = 15V$ $T_j = 25$ °C $T_j = 175$ °C	-	1.5 1.85	1.9 -	V

## ●IGBT Electrical Characteristics (at T<sub>j</sub> = 25°C unless otherwise specified)

Daramatar	Cymphal	Conditions	Values			Linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input Capacitance	C <sub>ies</sub>	V <sub>CE</sub> = 30V	-	4200	-	
Output Capacitance	C <sub>oes</sub>	V <sub>GE</sub> = 0V	-	104	-	pF
Reverse Transfer Capacitance	$C_{res}$	f = 1MHz	-	79	-	
Total Gate Charge	$Q_g$	V <sub>CE</sub> = 400V	-	141	-	
Gate - Emitter Charge	$Q_{ge}$	I <sub>C</sub> = 50A	-	30	-	nC
Gate - Collector Charge	$Q_{gc}$	V <sub>GE</sub> = 15V	-	52	-	
Turn - on Delay Time	t <sub>d(on)</sub>	I <sub>C</sub> = 50A, V <sub>CC</sub> = 400V	-	52	-	
Rise Time	t <sub>r</sub>	$V_{GE} = 15V, R_G = 10\Omega$	-	21	-	
Turn - off Delay Time	t <sub>d(off)</sub>	T <sub>j</sub> = 25°C	-	180	-	ns
Fall Time	t <sub>f</sub>	Inductive Load	-	33	-	
Turn - on Switching Loss	E <sub>on</sub>	*E <sub>on</sub> includes diode	-	1.18	-	
Turn - off Switching Loss	E <sub>off</sub>	reverse recovery	-	0.96	-	mJ
Turn - on Delay Time	t <sub>d(on)</sub>	I <sub>C</sub> = 50A, V <sub>CC</sub> = 400V	-	49	-	
Rise Time	t <sub>r</sub>	$V_{GE} = 15V, R_{G} = 10\Omega$	-	23	-	
Turn - off Delay Time	t <sub>d(off)</sub>	T <sub>j</sub> = 175°C	-	201	-	ns
Fall Time	t <sub>f</sub>	Inductive Load	-	72	-	
Turn - on Switching Loss	E <sub>on</sub>	*E <sub>on</sub> includes diode	-	1.18	-	
Turn - off Switching Loss	E <sub>off</sub>	reverse recovery	-	1.18	-	mJ
		I <sub>C</sub> = 200A, V <sub>CC</sub> = 520V				
Reverse Bias Safe Operating Area	RBSOA	V <sub>P</sub> = 650V, V <sub>GE</sub> = 15V	FU	LL SQUA	RE	-
		$R_G = 100\Omega, T_j = 175^{\circ}C$				

Fig.1 Power Dissipation vs. Case Temperature

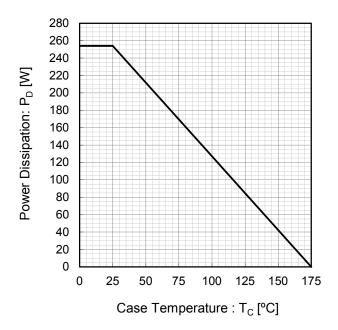


Fig.2 Collector Current vs. Case Temperature

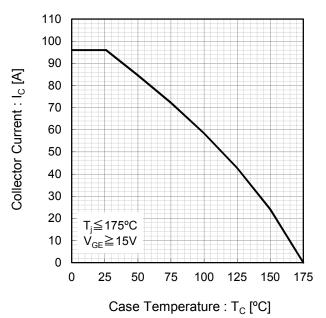


Fig.3 Forward Bias Safe Operating Area

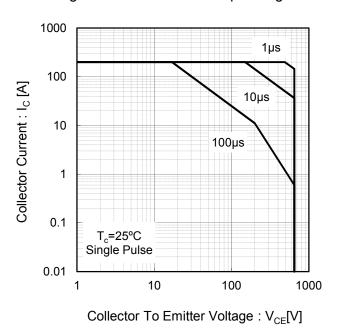


Fig.4 Reverse Bias Safe Operating Area

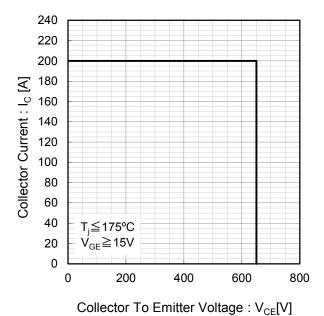


Fig.5 Typical Output Characteristics

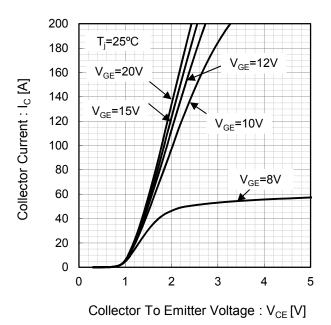
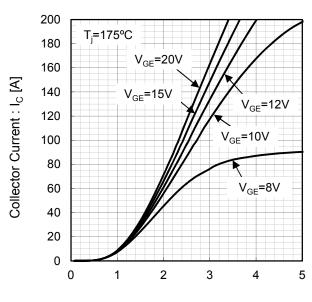


Fig.6 Typical Output Characteristics



Collector To Emitter Voltage :  $V_{CE}[V]$ 

Fig.7 Typical Transfer Characteristics

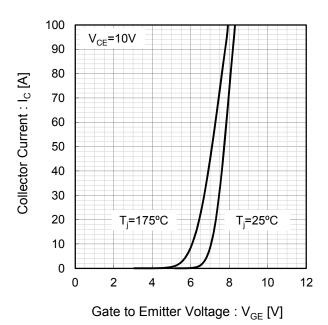
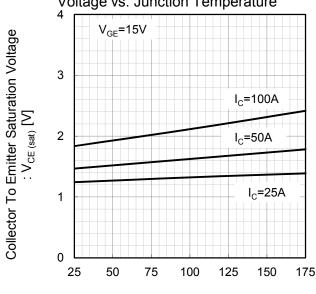
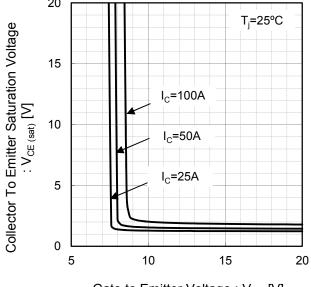


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature



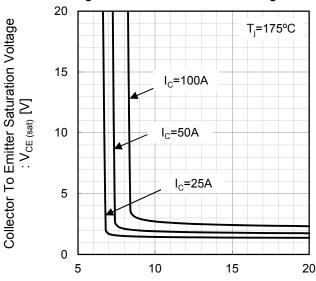
Junction Temperature :  $T_j$  [°C]

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate to Emitter Voltage : V<sub>GE</sub> [V]

Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate to Emitter Voltage : V<sub>GE</sub> [V]

Fig.11 Typical Switching Time vs. Collector Current

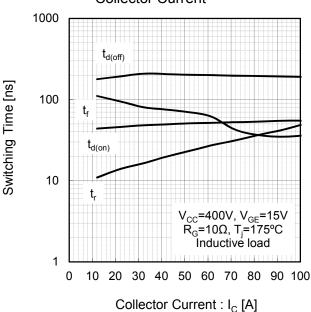


Fig.12 Typical Switching Time vs. Gate Resistance

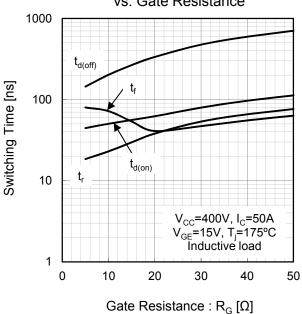
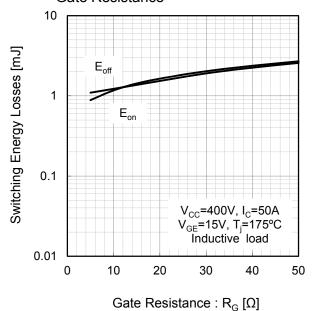


Fig.13 Typical Switching Energy Losses vs. Collector Current

10  $E_{off}$   $V_{CC}=400V, V_{GE}=15V$   $R_{G}=10\Omega, T_{j}=175^{\circ}C$ Inductive load

0 10 20 30 40 50 60 70 80 90 100

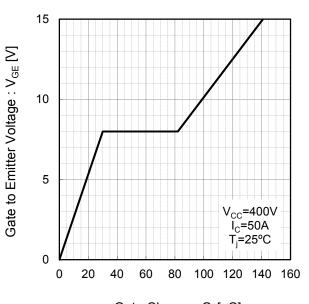
Fig.14 Typical Switching Energy Losses vs. Gate Resistance



Collector Current :  $I_C$  [A]

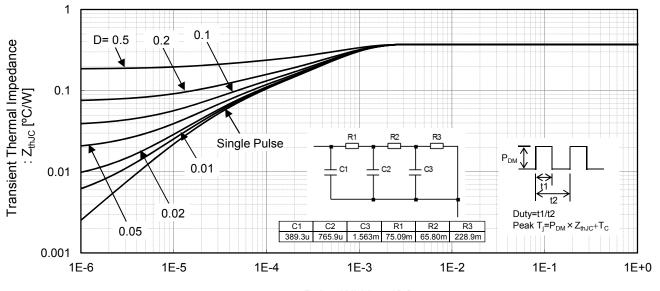
Fig.15 Typical Capacitance vs. Collector To Emitter Voltage 10000 Cies 1000 Capacitance [pF] Coes 100 Cres 10 f=1MHz V<sub>GE</sub>=0V 25°C 0.01 0.1 1 10 100 Collector To Emitter Voltage :  $V_{CE}[V]$ 

Fig.16 Typical Gate Charge



Gate Charge : Q<sub>q</sub>[nC]

Fig.17 Typical IGBT Transient Thermal Impedance



### •Inductive Load Switching Circuit and Waveform

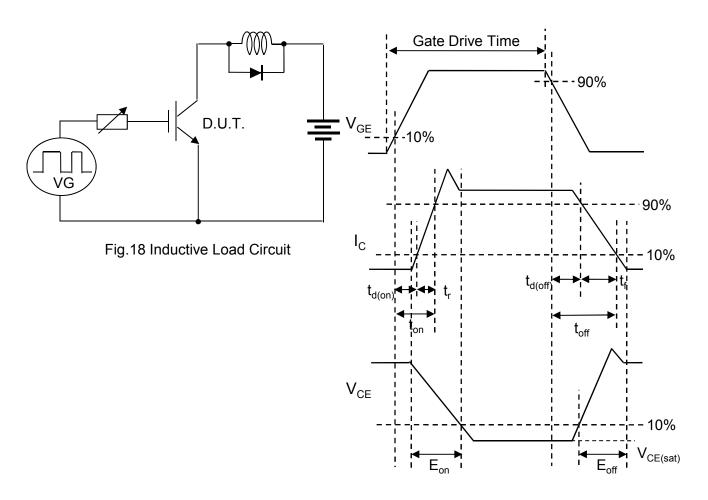


Fig.19 Inductive Load Waveform

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